Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A

Supplier Information

Company Name	TE Connectivity	Request Document ID		Contact Name	Benfer, David W	Contact Title	Staff Mfg & Process Dvl Engineer
Company Unique ID	TE Connectivity	Response Date	2018-04-03	Contact Email	dave.benfer@te.com		
Contact Phone Number		+1-717-986-3725					

Legal Statement

Supplier Acceptance	true

Legal Statement

The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.

Product

Manufacturer Item number	227161-2	Amount	11288.540895	Version	-	Identity	
Manufacturer Item Name	RTANG JK W/MTG PINS, BNC PCB	Weight Uom	mg	Mfr Site		Authority	
Date		UOM	Each				
EURoHS-0508	Product(s) meets EU RoHS requirements by application of the selected exemption(s)						
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products						
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH						
Complex Article Description	REACH Candidate Substances of Very High Concern according to Once an Article Always an Article are Not Yet Reviewed						

Product Disclosure

Sub-Item/Material/ Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub-Item	1	CONTACT,RTANG,SERIES BNC, LEAD				1.0	206.287668	mg	
Material	2	Phos Bronze				1.0	199.7	mg	
Substance	3	Copper	Supplier	7440-50-8	94.6985	1.0	189.1129	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	1.0	0.03994	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.01	1.0	0.01997	mg	
Substance	3	Tin	Supplier	7440-31-5	4.5	1.0	8.9865	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0050	1.0	0.009985	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	1.0	0.1997	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.01997	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	0.001997	mg	
Substance	3	Zinc	Supplier	7440-66-6	0.3	1.0	0.5991	mg	
Substance	3	Phosphorus	Supplier	7723-14-0	0.1	1.0	0.1997	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	0.1997	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	0.009985	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.09985	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.1	1.0	0.1997	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	9.985E-4	mg	
Material	2	Tin Plate				1.0	2.39678	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00479356	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	2.39031	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	0.00167775	mg	
Material	2	Nickel Plate				1.0	4.190888	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00838178	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.00419089	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	4.17832	mg	

Sub-Item	1	DIELECTRIC,SER BNC				1.0	363.2269	mg	
Material	2	PMP				1.0	363.2269	mg	
Substance	3	1-Octadecene, polymer with 1-hexadecene and 4-methyl-1-pentene	Supplier	81229-87-0	99.0	1.0	359.59463	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	1.0	1.0	3.63227	mg	
Sub-Item	1	HOUSING,STD,JACK,PCB,BNC-TNC				1.0	4084.4	mg	
Material	2	PBT-GF15				1.0	4084.4	mg	
Substance	3	Carbon black	Supplier	1333-86-4	1.5	1.0	61.266	mg	
Substance	3	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	0.5	1.0	20.422	mg	
Substance	3	2-Propenenitrile, polymer with ethenylbenzene	Supplier	9003-54-7	0.4	1.0	16.3376	mg	
Substance	3	1,4-Benzenedicarboxylic acid, 1,4-dimethyl ester, polymer with 1,4-butanediol	Supplier	30965-26-5	55.9	1.0	2283.1796	mg	
Substance	3	Antimony oxide (Sb2O3)	Supplier	1309-64-4	5.0	1.0	204.22	mg	
Substance	3	Acetic acid ethenyl ester, polymer with ethene	Supplier	24937-78-8	3.0	1.0	122.532	mg	
Substance	3	Phosphoric acid, zinc salt (2:3)	Supplier	7779-90-0	0.9	1.0	36.7596	mg	
Substance	3	Octadecanoic acid, 1,1-[2,2-bis[[(1-oxooctadecyl)oxy]methyl]-1,3-propanediyl] ester	Supplier	115-83-3	0.5	1.0	20.422	mg	
Substance	3	Glass, oxide, chemicals	Supplier	65997-17-3	17.0	1.0	694.348	mg	
Substance	3	Furan, tetrahydro-	Supplier	109-99-9	0.3	1.0	12.2532	mg	
Substance	3	Carbonic dichloride, polymer with 4,4-(1-methylethylidene)bis[2,6-dibromophenol] and phenol	Brominated Flame Retardants (other than PBBs or PBDEs)	94334-64-2	15.0	1.0	612.66	mg	
Sub-Item	1	MOUNTING POST, LEAD FREE PLATI				2.0	164.26	mg	
Material	2	Brass				2.0	161.36	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	2.0	0.0016136	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	2.0	0.016136	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	2.0	0.16136	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	2.0	0.016136	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.02	2.0	0.032272	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	2.0	0.0016136	mg	
Substance	3	Iron	Supplier	7439-89-6	0.35	2.0	0.56476	mg	
Substance	3	Zinc	Supplier	7440-66-6	32.7475	2.0	52.84137	mg	
Substance	3	Copper	Supplier	7440-50-8	63.0	2.0	101.6568	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	2.0	8.068E-4	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.01	2.0	0.016136	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	3.7	2.0	5.97032	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Substance	3	Nickel	Nickel	7440-02-0	0.05	2.0	0.08068	mg	
Material	2	Tin Plate				2.0	1.99	mg	

Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.00398	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	2.0	1.98463	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	2.0	0.001393	mg	
Material	2	Nickel Plate				2.0	0.91	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	2.0	0.00182	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	2.0	9.1E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	2.0	0.90727	mg	
Sub-Item	1	POST BNC PCB, LEAD-FREE, .869				1.0	77.234927	mg	
Material	2	Brass Wire				1.0	74.758	mg	
Substance	3	Copper	Supplier	7440-50-8	71.5	1.0	53.45197	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	7.4758E-4	mg	
Substance	3	Zinc	Supplier	7440-66-6	28.0226	1.0	20.94914	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	1.0	0.037379	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	1.0	7.4758E-4	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	1.0	0.037379	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	0.074758	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	1.0	0.00740104	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.0074758	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	1.0	0.037379	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	1.0	0.0037379	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	3.7379E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	1.0	0.14952	mg	
Material	2	Tin Plate				1.0	1.626249	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.0032525	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	1.0	1.62186	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	1.0	0.00113837	mg	
Material	2	Nickel Plate				1.0	0.850678	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.00170136	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	8.5068E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	0.84813	mg	
Sub-Item	1	BNC,PCB,SHELL				1.0	6228.8714	mg	
Material	2	Copper Plate				1.0	73.045	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.073045	mg	
Substance	3	Copper	Supplier	7440-50-8	99.9	1.0	72.97195	mg	
Material	2	Nickel Plate				1.0	54.6	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	0.0546	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	1.0	54.4362	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	1.0	0.1092	mg	
Material	2	Tri Chrome Film				1.0	0.2264	mg	
Substance	3	Silicate(2-), hexafluoro-, hydrogen (1:2)	Supplier	16961-83-4	30.0	1.0	0.06792	mg	
Substance	3	Chromium chloride (CrCl3), hydrate (1:6)	Supplier	10060-12-5	60.0	1.0	0.13584	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	10.0	1.0	0.02264	mg	
Material	2	Zinc Alloy				1.0	6101.0	mg	
Substance	3	Silicon	Supplier	7440-21-3	0.035	1.0	2.13535	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.02	1.0	1.2202	mg	
Substance	3	Tin	Supplier	7440-31-5	0.0030	1.0	0.18303	mg	

Substance	3	Manganese	Supplier	7439-96-5	0.06	1.0	3.6606	mg	
Substance	3	Copper	Supplier	7440-50-8	0.25	1.0	15.2525	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.01	1.0	0.6101	mg	
Substance	3	Zinc	Supplier	7440-66-6	95.0315	1.0	5797.87181	mg	
Substance	3	Aluminum	Supplier	7429-90-5	4.3	1.0	262.343	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	1.0	0.6101	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	1.0	0.06101	mg	
Substance	3	Iron	Supplier	7439-89-6	0.1	1.0	6.101	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	1.0	6.101	mg	
Substance	3	Magnesium	Supplier	7439-95-4	0.05	1.0	3.0505	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.02	1.0	1.2202	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.0050	1.0	0.30505	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	1.0	0.030505	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0040	1.0	0.24404	mg	